Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	4	"6759182".pn. or "6829050".pn. or "6774964".pn. or "6856366".pn.	US-PGPUB; USPAT	OR	ON	2005/05/18 10:18
L3	6	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:24
L4	3	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:26
L5	6	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (glass near2 transition) and (decomposition)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:27
L7	1	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature same (polymeriz$5 or cure or curing or cured or harden$4) same (glass near3 transition) same (decomposition))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:29
L8	0	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz$5 or cure or curing or cured or harden$4) and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:29
L9	6	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:29
L11	54	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz$5 or cure or curing or cured) and (glass near3 transition))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:31
L12	6	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (reflect$4 near3 (LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:31

L13	23	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect$4 near3 (LCD or (liquid adj crystal$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp$2 or roll$3 or die))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:32
L14	3	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect$4 near3 (LCD or (liquid adj crystal$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp$2 or roll$3 or die))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:33
L15	89	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((pattern or groove or plate or asperity or microasperity or stamp$2 or roll$3 or die or press or pressing or pressed) same (Tg or "T.sub.g" or (glass near2 transition)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 10:35
L17	3076	(427/162,163.1,164,165).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L18	577	(427/271).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L19	811	(427/277,278).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L20	8314	(427/372.2,374.1,375,384,385.5, 389.7).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L21	1287	(264/1.31,1.1,1.34,1.9).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L22	1277	(349/67,113).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 10:46
L23	12581	((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:47

L24	2	(((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.)) and (microasperity or (micro adj asperity))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:47
L25	0	((427/271).CCLS.) and ((349/67, 113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:48
L26	0	((427/277,278).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:48
L27	0	((427/372.2,374.1,375,384,385.5, 389.7).CCLS.) and ((349/67,113). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L28	0	((264/1.31,1.1,1.34,1.9).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L29	2	((427/162,163.1,164,165).CCLS.) and ((349/67,113).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L30	34	((427/162,163.1,164,165).CCLS.) and ((427/271).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L31	19	((427/162,163.1,164,165).CCLS.) and ((427/277,278).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L32	64	((427/162,163.1,164,165).CCLS.) and ((264/1.31,1.1,1.34,1.9). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 10:49
L33	0	((427/277,278).CCLS.) and (reflect$5 with (LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:50
L34	5	((427/277,278).CCLS.) and ((LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:50
L35	6	(microasperity or (micro adj asperity)) and (reflect$5 with (LCD or (liquid adj crystal$4 adj display)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:51
L36	48	((349/67,113).CCLS.) and (pattern$3 with (stamp$3 or master or emboss$4 or roll$3))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:52

L38	78	((reflect$5 with (LCD or (liquid adj crystal$4 adj display))) and ((pattern$3 or resin$4 or polyimide or polymer$2) with (stamp$3 or master or emboss$4 or roll$3)) and (((427/162,163.1, 164,165).CCLS.) ((427/271).CCLS.) ((427/277,278).CCLS.) ((427/372.2,374.1,375,384,385.5, 389.7).CCLS.) ((264/1.31,1.1,1. 34,1.9).CCLS.) ((349/67,113). CCLS.))) not (((349/67,113).CCLS.) and (pattern$3 with (stamp$3 or master or emboss$4 or roll$3)))	US-PGPUB; USPAT	OR	ON	2005/05/18 10:54
L39	1	"5071597".pn.	US-PGPUB; USPAT	OR	ON	2005/05/18 10:58
L40	18	((427/277,278).CCLS.) and ((glass adj transition) or Tg or "T.sub.g" or "T.sub.G")	US-PGPUB; USPAT	OR	ON	2005/05/18 10:59
L41	18	((427/277,278).CCLS.) and ((glass adj transition) or Tg or "T.sub.g" or "T.sub.G")	US-PGPUB; USPAT	OR	ON	2005/05/18 10:59
L43	1003	((coat$3 or deposit$3 or apply$3 or application or spincoat$3) with (temperature) with (lower or below or under) with ((polymeriz$5 or curing) near3 temperature))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:06
L44	0	(((coat$3 or deposit$3 or apply$3 or application or spincoat$3) with (temperature) with (lower or below or under) with ((polymeriz$5 or curing) near3 temperature))) and ((427/277, 278).CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:06
L45	78	(((coat$3 or deposit$3 or apply$3 or application or spincoat$3) with (temperature) with (lower or below or under) with ((polymeriz$5 or curing) near3 temperature))) and (((427/162, 163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:06

L46	46	((coat$3 or deposit$3 or apply$3 or application or spincoat$3) with (temperature) with (lower or below or under) with ((polymeriz$5 or curing or reaction) near3 temperature)) and ((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near6 (glass adj transition)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:10
L47	1149	((coat$3 or deposit$3 or spincoat$3) with (temperature) with (lower or below or under) near4 ((polymeriz$5 or curing or reaction) near3 temperature))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:10
L48	37	((coat$3 or deposit$3 or spincoat$3) with (temperature) with (lower or below or under) near4 ((polymeriz$5 or curing or reaction) near3 temperature with (begin$5 or initiat$8 or start$5 or commenc$5)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:11
L49	50	((coat$3 or deposit$3 or spincoat$3) with (temperature) with (lower or below or under) near4 ((polymeriz$5 or curing or reaction) near3 temperature with (begin$5 or initiat$8 or start$5 or commenc$5)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:11
L50	1	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((427/277,278). CCLS.)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:16
L51	5	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:16

L53	53	(((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))) not (((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:17
L55	2	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:18
L56	204	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master or emboss$5))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:19

L57	85	(((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press or pressing or pressed or stamp$3 or roll$3 or die or master or emboss$5))) not ((((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))) not (((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press$3 or stamp$3 or roll$3 or die or master) near7 (emboss$5 or pattern$3 or concave or convex))))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:20
L58	7	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (coat$3 or deposit$4 or film or layer or apply$3 or application) with (benefi$8 or advantag$7 or prefer$6 or optim$6))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:21
L59	78	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi$8 or advantag$7 or prefer$6 or optim$6))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:22
L60	30	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi$8 or advantag$7 or prefer$6 or optim$6))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:23
L61	41	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften$4)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:23

L62	13	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften$4)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:24
L63	35	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:24
L65	43	((cure or cured or curing or harden$3 or polymeriz$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2)))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:24
L66	29	((cure or cured or curing or harden$3 or polymeriz$5)) same ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2))) same ((stamp$5 or emboss$5 or roll$4 or die or press or pressed or pressing) near6 (pattern$4 or convex or concave or indent$6))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:25
L68	79	(((cure or cured or curing or harden$3 or polymeriz$5)) same ((coat$3 or deposit$3 or apply$3) with (monomer$3 or oligomer$2 or prepolymer$2 or (pre adj polymer$2))) same ((stamp$5 or emboss$5 or roll$4 or die or press or pressed or pressing))) and (((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277, 278).CCLS.) ((427/372.2,374.1, 375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:26
L70	80	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (Tg or "T:sub:g")	US-PGPUB; USPAT	OR	ON	2005/05/18 11:27

L72	91	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:28
L74	5	(stress$3) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:29
L75	1	(relax$7) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:29
L76	20	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near4 (soften$4) with (Tg or "T.sub.g" or (glass near2 transition))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:29
L77	0	(stress$3 or relax$7) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:30
L78	33	(coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:30
L80	355	(((cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))) not ((coat$3 or deposit$3 or apply$3 or film or layer) with (cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))	US-PGPUB; USPAT	OR	ON	2005/05/18 11:30
L82	59	(((cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)) same (stamp$5 or pattern$4 or press$3 or die or emboss$5)	US-PGPUB; USPAT	OR	ON	2005/05/18 11:32

L84	13	((cure or cured or curing or harden$3 or polymeriz$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)) same (stamp$5 or pattern$4 or press$3 or die or emboss$5)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:32
L85	14	(spincoat$3 or (spin adj coat$3)) with (resin$5 or monomer$3 or prepolymer$4 or solution or liquid) with (temperature) with (lower or below or under) near4 (cure or cured or curing or polymeriz$6 or harden$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:32
L87	14	(spincoat$3 or (spin adj coat$3)) with (temperature) near3 (lower or below or under) near4 (cure or cured or curing or polymeriz$6 or harden$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:33
L88	13	((coat$4 or spincoat$4 or deposit$5 or film or layer or apply$4 or application) with (polymer$2 or resin$4 or plastic or oligomer$4 or monomer$4 or prepolymer$4) with (temperature) with (below or lower or under or beneath or less) with (cure or cured or curing or harden$4 or polymeriz$6 or reaction) with (start$4 or initiat$7 or begin$5 or commenc$6)) and ((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (temperature) with (above or greater or higher or over or increas$5) with (Tg or "T.sub.g" or (glass adj transition))) and (microasperity or pattern$4 or emboss$4 or stamp$4 or master or die or mold$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:43
L89	5657	((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (temperature) with (above or greater or higher or over or increas$5) with (Tg or "T.sub.g" or (glass adj transition))) and ((microasperity or pattern$4 or emboss$4 or stamp$4 or master or die or mold$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:45

L90	1469	((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (temperature) with (above or greater or higher or over or increas$5) with (Tg or "T.sub.g" or (glass adj transition))) same ((microasperity or pattern$4 or emboss$4 or stamp$4 or master or die or mold$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:51
L91	1180	((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (temperature) with (above or greater or higher or over or increas$5) near3 (Tg or "T.sub.g" or (glass adj transition))) same ((microasperity or pattern$4 or emboss$4 or stamp$4 or master or die or mold$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:46
L92	39	L91 and L23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 11:46
L93	92	((heat$5 or cured or cure or curing or harden$5 or bake or baked or baking or polymeriz$7) with (coat$5 or film or layer or deposit$5) with (temperature) with (above or greater or higher or over or increas$5) with (Tg or "T. sub.g" or (glass adj transition))) same ((microasperity or emboss$4 or stamp$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:02
L94	1299	((microasperity or emboss$4 or stamp$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) with (cure or cured or curing or polymeriz$8 or harden$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:04

L95	11	((microasperity or emboss$4 or stamp$4) with (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) with (cure or cured or curing or polymeriz$8 or harden$5)) same (Tg or "T.sub.g" or (glass adj transition))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:08
L96	262	((microasperity or emboss$4 or stamp$4) near3 (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) near2 (cure or cured or curing or polymeriz$8 or harden$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:32
L97	25	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5 or soften$5 or melt$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:13
L98	71	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5 or soften$5 or melt$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold$4 or die or pattern$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:15

L99	91	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5 or soften$5 or melt$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition))) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold$4 or die or pattern$4 or imprint$5 or print$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:38
L100	15	L96 and L23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:31
L101	247	L96 not L100	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:31
L102	13	((microasperity or emboss$4 or stamp$4) near3 (coat$4 or film or layer or resin$5 or polymer$5 or plastic) with (after or before or prior or subsequent$4 or previous$4) near2 (cure or cured or curing or polymeriz$8 or harden$5)) same (Tg or soften$5 or melt$5 or "T.sub.g" or (glass near2 transition))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:33
L103	1180	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften$4 or melt$5 or flow$9)) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold$4 or die or pattern$4 or imprint$5 or print$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:48
L104	41	L103 and L23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:41

L105	382	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften$4 or melt$5 or flow$9)) same (stamp$5 or emboss$5 or pressed or press or pressing or microasperity or (micro adj asperity) or mold$4 or die or pattern$4 or imprint$5 or print$5))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:49
L106	34	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften$4 or melt$5 or flow$9)) same (stamp$5 or emboss$5 or (pressed or press or pressing or mold$4 or die) near5 (microasperity or (micro adj asperity) or pattern$4 or imprint$5)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/18 12:53
L107	101	(((cure or cured or curing or polymeriz$8 or harden$5) near3 (coat$4 or film or layer)) same ((heat$5) with (coat$5 or film or layer or polymer$4 or resin$5 or cured or hardened or polymerized) with (Tg or "T.sub.g" or (glass adj transition) or soften$4 or melt$5 or flow$9)) same (stamp$5 or emboss$5 or (pressed or press or pressing or mold$4 or die) near5 (microasperity or (micro adj asperity) or pattern$4 or imprint$5)))	US-PGPUB; USPAT	OR	ON	2005/05/18 12:54
L108	92	L107 not L104	US-PGPUB; USPAT	OR	ON	2005/05/18 12:54